10A, 600V Super Fast Surface Mount Rectifier

FEATURES

- AEC-Q101 qualified
- Glass passivated chip junction
- Ideal for automated placement
- High efficiency, low V_F
- High surge current capability
- Low power loss
- Moisture sensitivity level: level 1, per J-STD-020
- RoHS Compliant
- Halogen-free according to IEC 61249-2-21

APPLICATIONS

- DC to DC converter
- Automotive application
- Car lighting
- Snubber
- Freewheeling application

MECHANICAL DATA

- Case: TO-263AB (D²PAK)
- Molding compound meets UL 94V-0 flammability rating
- Terminal: Matte tin plated leads, solderable per J-STD-002
- Meet JESD 201 class 2 whisker test
- Polarity: As marked
- Weight: 1.33g (approximately)

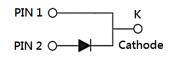
KEY PARAMETERS			
PARAMETER	VALUE	UNIT	
I _F	10	А	
V _{RRM}	600	V	
I _{FSM}	125	А	
T _{J MAX}	150	°C	
Package	TO-263AB (D ² PAK)		
Configuration	Single die		



HALOGEN



TO-263AB (D²PAK)



ABSOLUTE MAXIMUM RATINGS (T _A = 25°C unless otherwise noted)				
PARAMETER	SYMBOL	SFAS1008GH	UNIT	
Marking code on the device		SFAS1008G		
Repetitive peak reverse voltage	V _{RRM}	600	V	
Reverse voltage, total rms value	V _{R(RMS)}	420	V	
Forward current	I _F	10	Α	
Surge peak forward current, 8.3ms single half sine wave superimposed on rated load	I _{FSM}	125	А	
Junction temperature	TJ	-55 to +150	°C	
Storage temperature	T _{STG}	-55 to +150	°C	



THERMAL PERFORMANCE			
PARAMETER	SYMBOL	ТҮР	UNIT
Junction-to-case thermal resistance	R _{eJC}	2.2	°C/W

ELECTRICAL SPECIFICATIONS (T _A = 25°C unless otherwise noted)					
PARAMETER	CONDITIONS	SYMBOL	ТҮР	MAX	UNIT
Forward voltage ⁽¹⁾	$I_F = 10A, T_J = 25^{\circ}C$	V _F	-	1.7	V
Reverse current @ rated $V_R^{(2)}$	$T_J = 25^{\circ}C$	I _R	-	10	μA
	$T_{\rm J} = 100^{\circ}C$		-	400	μA
Junction capacitance	$1MHz, V_{R} = 4.0V$	CJ	60	-	pF
Reverse recovery time	$I_F = 0.5A, I_R = 1.0A$ $I_{rr} = 0.25A$	t _{rr}	-	35	ns

Notes:

1. Pulse test with PW = 0.3ms

2. Pulse test with PW = 30ms

ORDERING INFORMATION		
ORDERING CODE	PACKAGE	PACKING
SFAS1008GH	TO-263AB (D ² PAK)	800 / Tape & Reel



CHARACTERISTICS CURVES

 $(T_A = 25^{\circ}C \text{ unless otherwise noted})$

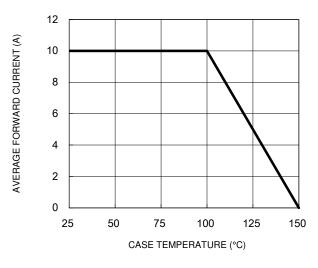


Fig.1 Forward Current Derating Curve

Fig.3 Typical Reverse Characteristics

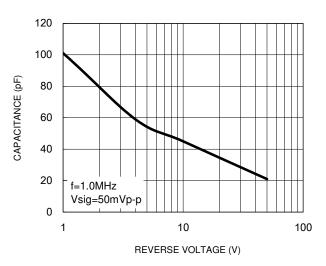


Fig.2 Typical Junction Capacitance

Fig.4 Typical Forward Characteristics

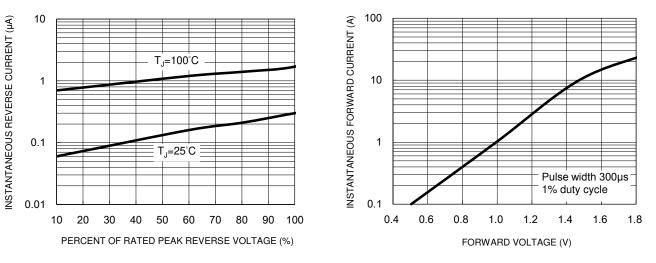




Fig.5 Maximum Non-Repetitive Forward Surge Current

Version: A2103



CHARACTERISTICS CURVES

 $(T_A = 25^{\circ}C \text{ unless otherwise noted})$

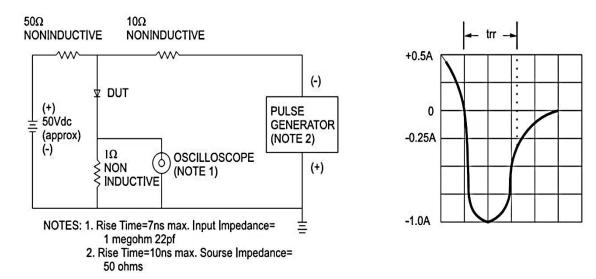
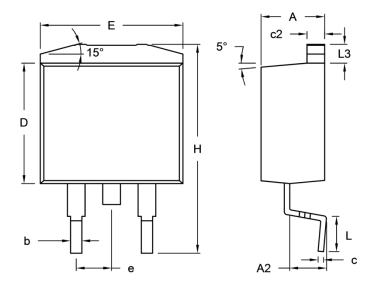


Fig.6 Reverse Recovery Time Characteristic and Test Circuit Diagram



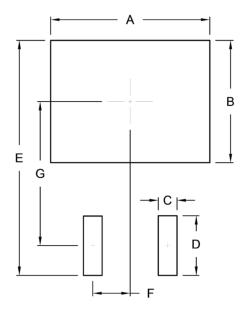
PACKAGE OUTLINE DIMENSIONS

TO-263AB (D²PAK)



	DIM. Unit (mm) Min. Max.		Unit ((inch)
			Min.	Max.
A	4.44	4.70	0.175	0.185
A2	2.03	2.79	0.080	0.110
b	0.68	0.94	0.027	0.037
с	0.36	0.53	0.014	0.021
c2	1.14	1.40	0.045	0.055
D	8.25	9.25	0.325	0.364
E	-	10.50	-	0.413
е	2.41	2.67	0.095	0.105
н	14.60	15.88	0.575	0.625
L	2.29	2.79	0.090	0.110
L3	1.14	1.40	0.045	0.055

SUGGESTED PAD LAYOUT



Symbol	Unit (mm)	Unit (inch)
A	10.80	0.425
В	8.30	0.327
С	1.27	0.050
D	4.05	0.159
E	15.95	0.628
F	2.54	0.100
G	9.775	0.385

MARKING DIAGRAM



P/N	= Marking Code
G	= Green Compound
YWW	= Date Code
F	= Factory Code



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